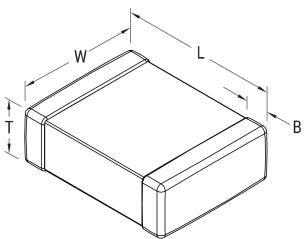


## C1812F394K2RAC7210

SMD Comm X7R FO, Ceramic, 0.39 uF, 10%, 200 VDC, X7R, SMD, MLCC, Open Mode, Temperature Stable, 1812



Click here for the 3D model.

Dimensions		
Chip Size	1812	
L	4.5mm +/-0.3mm	
W	3.2mm +/-0.3mm	
Т	1.9mm +/-0.20mm	
В	0.6mm +/-0.35mm	

Packaging Specifications		
Packaging	T&R, 330mm, Plastic Tape	
Packaging Quantity	2000	

General Information	
Series	SMD Comm X7R FO
Style	SMD Chip
Description	SMD, MLCC, Open Mode, Temperature Stable
Features	Open Mode, Temperature Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	185 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.39 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	200 VDC
Dielectric Withstanding Voltage	500 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	2.5641 GOhms

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